



Power line chokes

3.4 μ H / 1 MHz, 25 A, +110 °C

Ordering code: B82116B2828A010

Date: 2016-07-07

Version: 01

Rod core choke

Rated current: 25 A / +110 °C

Rated inductance: 3.4 μ H / 1 MHz



Construction

- Rod core choke
- Ferrite core
- Single layer winding
- Core and winding glued

Features

- High resonance frequency
- Enameled wire in accordance to EN 60317-13, Grade 1
- Wire class 200, UL listed
- Suitable for wave soldering or welding
- RoHS compatible

Applications

- EMC choke

Terminals

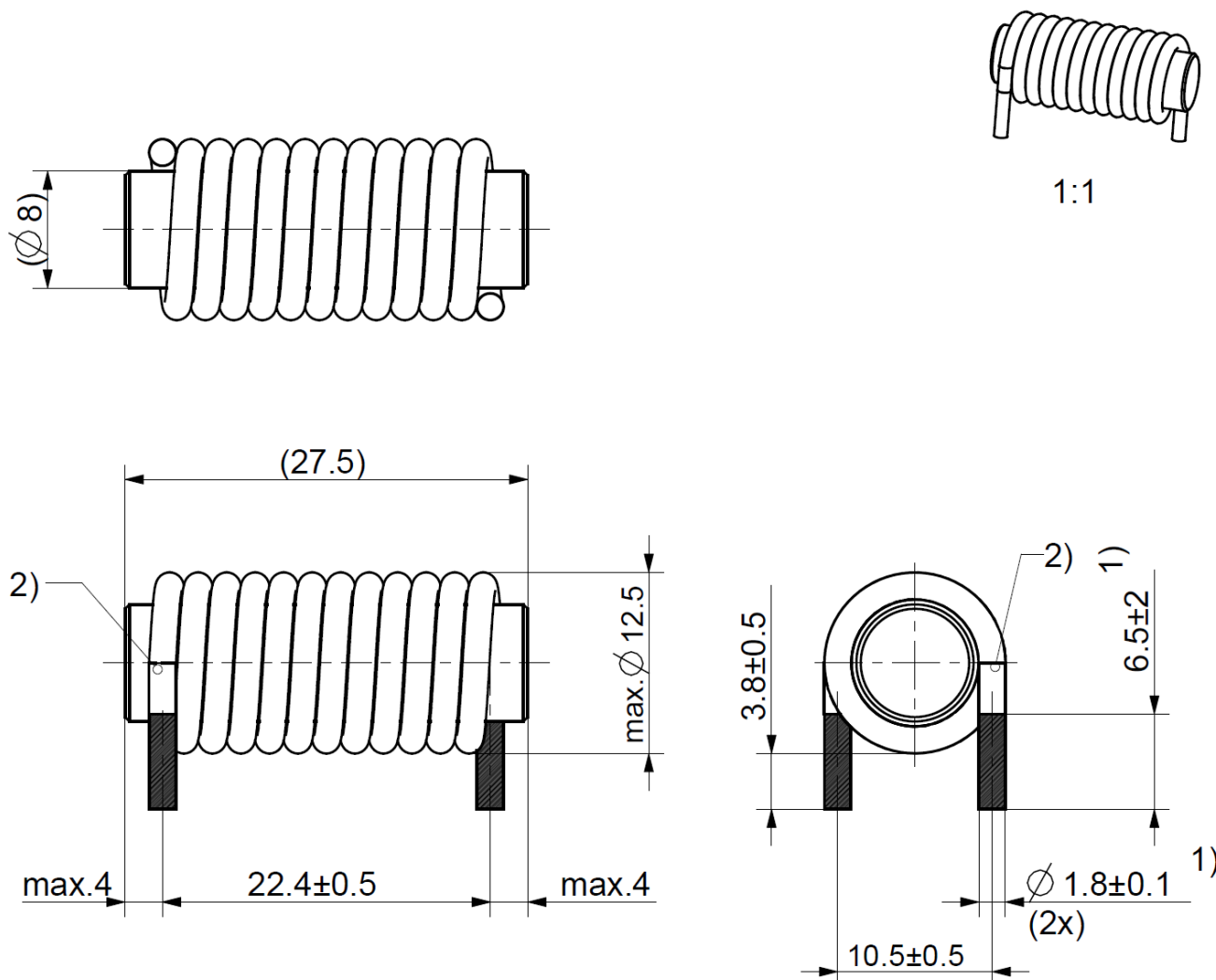
- Ends of winding wire
- Pins hot dip tinned with Sn99Cu

Delivery mode

- Trays in cardboard box

Rod core choke

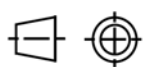
Dimensional drawing



1) Stripped area – tinned with Sn99Cu
Bare copper above the tinned area is permissible
Valid for both terminals

2) At this position a little hole in wire coating may appear caused by wire holder
of winding machine

Longitudinal axis of core is not central to winding



All dimensions in mm
ISO 2768-cL

Tolerance
ISO 8015

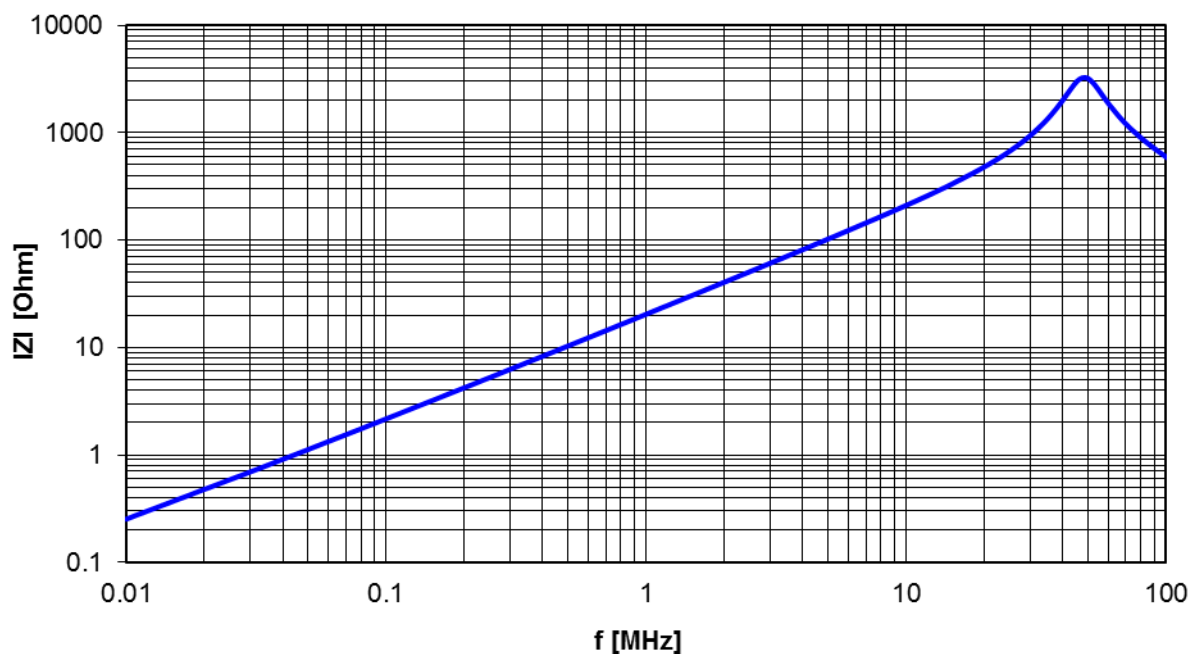
Dimensions
ISO 14405

Technical data and measuring conditions

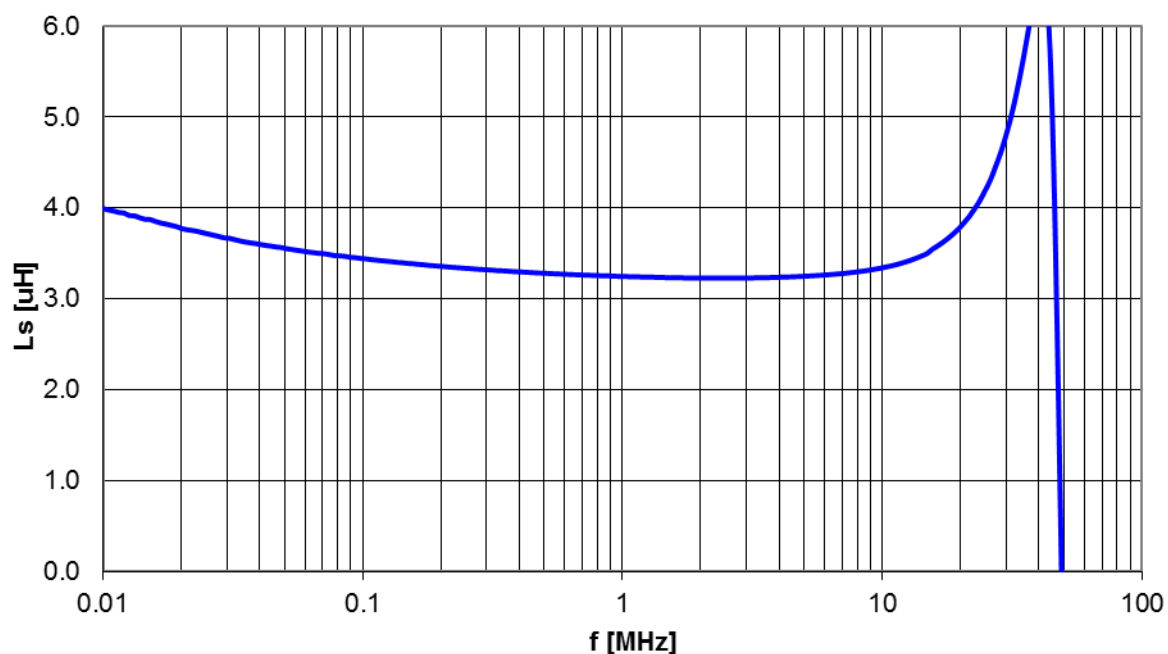
Rated temperature T_R	+110 °C
Rated current I_R	25 A Referred to DC current and rated temperature. Higher rated current or rated temperature requires additional cooling.
Rated inductance L_R	3.4 μ H / 1 MHz Measured with Agilent 4284A, 1 mA, +20 °C
Inductance $L_{(10\text{ kHz})}$ (only for information)	3.9 μ H / 10 kHz Measured with Agilent 4284A, 1 mA, +20 °C
Inductance tolerance	$\pm 20\%$ at +20 °C
Inductance decrease $\Delta L/L_0$	$\leq 10\%$ at DC magnetic bias with 40 A, +20 °C
DC resistance R_{typ}	2.6 m Ω typical value Measured at +20 °C
Operating temperature range	-40°C ... +170°C
Weight	Approx. 16 g
Wire insulation	Leaks in insulation of wire in accordance to EN 60317-0-1 allowed
Ferrite core surface irregularities	The standard IEC 60424-4 is the basis for the visual inspection of surface irregularities. These surface irregularities have no impact regarding function, manufacture ability and reliability of the component. No further spalling of core material permissible.

Rod core choke

Impedance $|Z|$ versus frequency (Typical values measured at +20 °C)

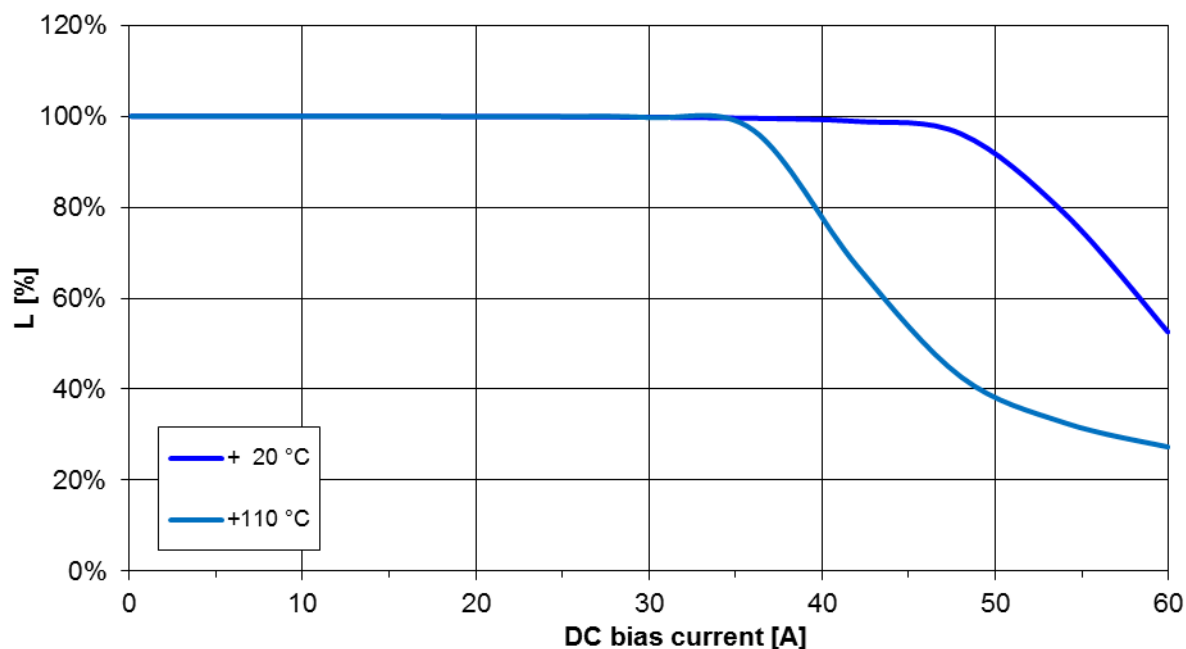


Inductance L_s versus frequency (Typical values measured at +20 °C)



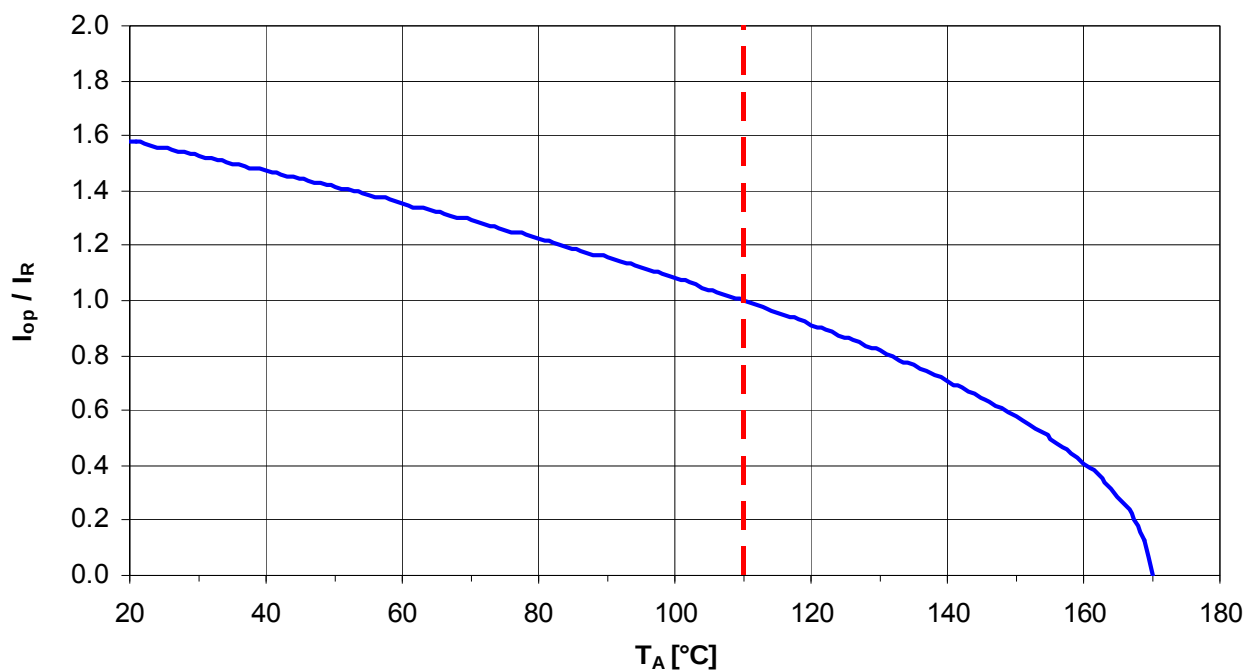
Inductance L/L_0 versus DC bias current I

(Typical values measured at +20 °C, +110 °C Measured with DC BIAS method)



Current derating I_{op}/I_R versus ambient temperature T_A

(rated temperature $T_R = +110$ °C)



Rod core choke**Cautions and warnings**

- Please note the recommendations in our Inductors data book (latest edition) and in the data sheets.
 - Particular attention should be paid to the derating curves given there. Derating must be applied in case the ambient temperature in the application exceeds the rated temperature of the component.
 - Ensure the operation temperature (which is the sum of the ambient temperature and the temperature rise caused by losses / self-heating) of the component in the application does not exceed the maximum value specified in operating temperature range.
 - The soldering conditions should also be observed. Temperatures quoted in relation to wave soldering refer to the pin, not to the housing.
- If the components are to be washed varnished, it is necessary to check whether the washing varnish agent that is used has a negative effect on the wire insulation, any plastics that are used, or on glued joints. In particular, it is possible for washing varnish agent residues to have a negative effect in the long-term on wire insulation.

Washing processes may damage the product due to the possible static or cyclic mechanical loads (e.g. ultrasonic cleaning). They may cause cracks to develop on the product and its parts, which might lead to reduced reliability or lifetime.
- The following points must be observed if the components are potted in customer application:
 - Many potting materials shrink as they harden. They therefore exert a pressure on the plastic housing or core. This pressure can have a deleterious effect on electrical properties and, in extreme cases, can damage the core or plastic housing mechanically;
 - It is necessary to check whether the potting material used attacks or destroys the wire insulation, plastics or glue;
 - The effect of the potting material can change the high-frequency behaviour of the components.
- Ferrites are sensitive to direct impact. This can cause the core material to flake, or lead to breakage of the core.
- Even for customer-specific products, conclusive validation of the components in the circuit can only be carried out by the customer.

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